20 STERN AVE. SPRINGFIELD, NEW JERSEY 07081 U.S.A.

TELEPHONE: (973) 376-2922

(212) 227-6005

FAX: (973) 376-8960

RFL1N12L, RFL1N15L

1A, 120V and 150V, 1.900 Ohm, Logic Level, N-Channel Power MOSFETs

Features

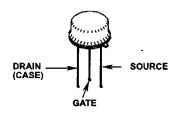
- 1A, 120V and 150V
- r_{DS(ON)} = 1.900Ω

Ordering Information

PART NUMBER	PACKAGE	BRAND
RFL1N12L	TO-205AF	RFL1N12L
RFL1N15L	TO-205AF	RFL1N15L

NOTE: When ordering, use the entire part number.

JEDEC TO-205AF

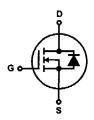


Description

These are N-Channel enhancement mode silicon gate power field effect transistors specifically designed for use with logic level (5V) driving sources in applications such as programmable controllers, automotive switching, and solenoid drivers. This performance is accomplished through a special gate oxide design which provides full rated conduction at gate biases in the 3V to 5V range, thereby facilitating true on-off power control directly from logic circuit supply voltages.

Formerly developmental type TA09528.

Symbol





Absolute Maximum Ratings T_C = 25°C, Unless Otherwise Specified

	RFL1N12L	RFL1N15L	UNITS
Drain to Source Voltage (Note 1)	120	150	٧
Drain to Gate Voltage (R _{GS} = 1MΩ) (Note 1)V _{DGR}	120	150	٧
Continuous Drain CurrentID	1	1	Α
Pulsed Drain Current (Note 3)	5	5	Α
Gate to Source Voltage	±10	±10	٧
Maximum Power Dissipation	8.33	8.33	W
Above T _C = 25 ^o C, Derate Linearly	0.0667	0.0667	W/°C
Operating and Storage Temperature	-55 to 150	-55 to 150	°C
Maximum Temperature for Soldering Leads at 0.063in (1.6mm) from Case for 10s	260	260	°C .

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

1. $T_J = 25^{\circ}C$ to $125^{\circ}C$.

Electrical Specifications $T_C = 25^{\circ}C$, Unless Otherwise Specified

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	ТҮР	MAX	UNITS
Drain to Source Breakdown Voltage RFL1N12L	BV _{DSS}	I _D = 250μA, V _{GS} = 0	120	-	-	v
RFL1N15L	1		150	- "	-	٧
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = 250μA, (Figure 8)	1	-	2	٧
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = Rated BV _{DSS}	-	-	1	μА
		V _{DS} = 0.8 x Rated BV _{DSS} , T _C = 125°C	-	-	25	μΑ
Gate to Source Leakage Current	IGSS	V _{GS} = ±10V, V _{DS} = 0	-		±100	μΑ
Drain to Source On Resistance (Note 2)	「DS(ON)	I _D = 1A, V _{GS} = 5V, (Figures 6, 7)	-	-	1.900	Ω
Drain to Source On Voltage (Note 2)	V _{DS(ON)}	I _D = 1A, V _{GS} = 5V	-	-	1.9	٧
Turn-On Delay Time	t _d (ON)	$I_D \approx$ 1A, V_{DD} = 75V, R_G = 6.25Ω, R_L = 75Ω, V_{GS} = 5V, (Figures 10, 11, 12)	-	10	25	ns
Rise Time	t _r		-	10	45	ns
Turn-Off Delay Time	t _{d(OFF)}		-	24	45	ns
Fall Time	tf		-	30	50	ns
Input Capacitance	C _{ISS}	V _{GS} = 0V, V _{DS} = 25V, f = 1MHz,(Figure 9)	-	-	200	рF
Output Capacitance	Coss		-	#	80	pF
Reverse Transfer Capacitance	C _{RSS}		-	-	35	pF
Thermal Resistance Junction to Case	R ₀ JC		-	-	15	oc/M

Source to Drain Diode Specifications

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Source to Drain Diode Voltage (Note 2)	V _{SD}	I _{SD} = 1A	-	-	1.4	٧
Diode Reverse Recovery Time	t _{rr}	l _{SD} = 1A, dl _{SD/} dt = 50A/μs	-	150	-	ns

NOTES:

- 2. Pulse test: width $\leq 300 \mu s$ duty cycle $\leq 2\%$.
- 3. Repetitive rating: pulse witdh limited by maximum junction temperature.